

EUROPEAN PATENT OFFICE

Patent Abstracts of Japan

PUBLICATION NUMBER : 2002225175
PUBLICATION DATE : 14-08-02

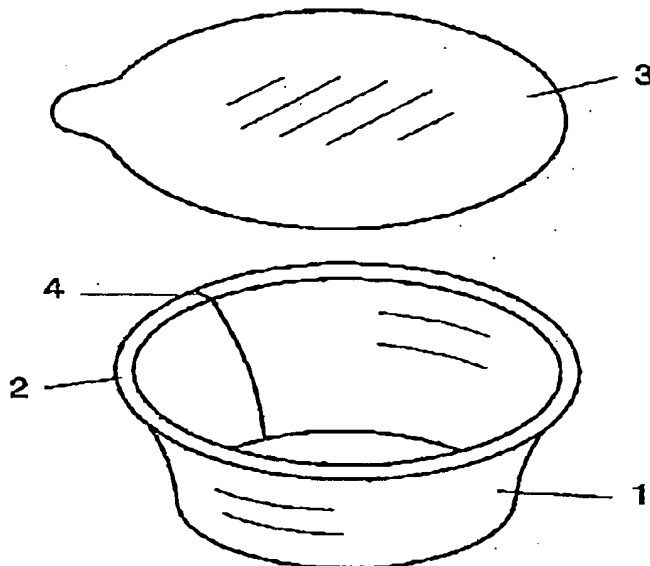
APPLICATION DATE : 31-01-01
APPLICATION NUMBER : 2001022578

APPLICANT : TOKAI ALUMINUM FOIL CO LTD;

INVENTOR : NISHIJIMA ZUIKI;

INT.CL. : B32B 15/08 B32B 15/20 B65D 53/04

TITLE : LID MATERIAL



ABSTRACT : PROBLEM TO BE SOLVED: To provide a heat-sealable lid material having no problem in adhesiveness even if bonded to a surface having unevenness.

SOLUTION: The lid material consists of aluminum, a resin layer and a heat sealer layer. The resin layer comprises at least one kind of a resin selected from high density polyethylene, medium density polyethylene, straight chain low density polyethylene, polypropylene, an ionomer, an ethylene acrylic acid copolymer resin and an ethylene methacrylic acid copolymer resin.

COPYRIGHT: (C)2002,JPO